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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Michiyasu KOMATSU, et al.

SERIAL NO.: NEW U.S. PCT APPLICATION

FILED: HERewith

INTERNATIONAL APPLICATION NO.: PCT/JP04/17531

INTERNATIONAL FILING DATE: November 18, 2004

FOR: HIGH THERMALLY CONDUCTIVE ALUMINUM NITRIDE SINTERED  
PRODUCT

**REQUEST FOR PRIORITY UNDER 35 U.S.C. 119  
AND THE INTERNATIONAL CONVENTION**

Commissioner for Patents  
Alexandria, Virginia 22313

Sir:

In the matter of the above-identified application for patent, notice is hereby given that  
the applicant claims as priority:

**COUNTRY**  
Japan

**APPLICATION NO**  
2003-392464

**DAY/MONTH/YEAR**  
21 November 2003

Certified copies of the corresponding Convention application(s) were submitted to the  
International Bureau in PCT Application No. PCT/JP04/17531. Receipt of the certified  
copy(s) by the International Bureau in a timely manner under PCT Rule 17.1(a) has been  
acknowledged as evidenced by the attached PCT/IB/304.

Respectfully submitted,  
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